101465C

RD331.8-200-12.5W- 331.8 MHz Dispersive Delay Line 200 MHz Bandwidth

Specifications

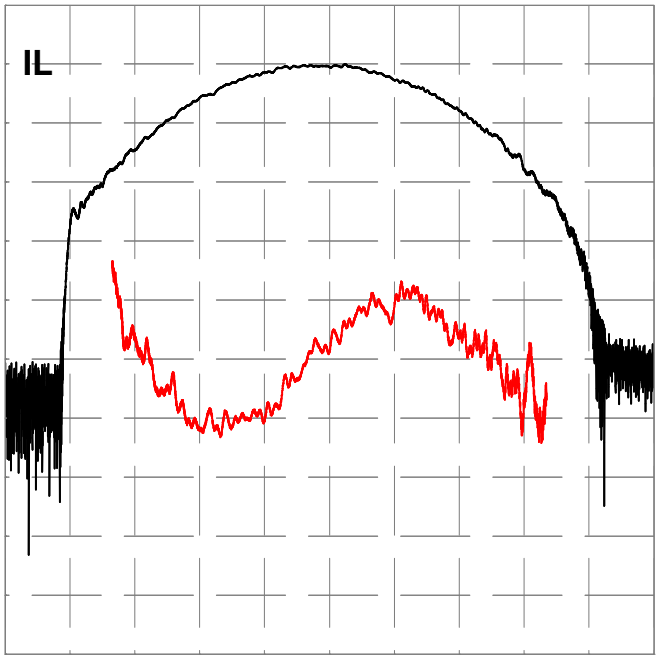
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	F_0		331.8		MHz
Bandwidth	B		200		MHz
Dispersion	T		12.5		µsec
Delay	T_0	9.44	9.452	9.48	µsec
Insertion Loss	IL		44.7	54	dB
Slope	S_0	–0.0657	–0.0656	–0.0655	µs/MHz
Pulse Width at –3 dB			0.0074	0.0084	µsec
Sidelobes for $\|t - T_0\| < T$			–25.7	–18	dB
Time Spurious for $\|t - T_0\| > T$			–76	–70	dB
Substrate Material	YZ-LN				

Notes

1. Center Frequency (F_0) and Bandwidth (B) are defined, not measured. Dispersion (T) is defined as $|B * S_0|$.
2. Insertion Loss is the minimum loss for $|f - F_0| < .5B$
3. Delay and Slope determined by best fit quadratic pulse in $|f - F_0| < .5B$.
4. Specifications are at 22 °C only. Unit will operate undamaged from –54 °C to 125 °C with shifts $dF_0 = -x * F_0$, $dT_0 = x * (T_0 + S_0 * F_0)$, $dS_0 = x * 2 * S_0$, where x = 94E-6 * (temperature – 22 °C)

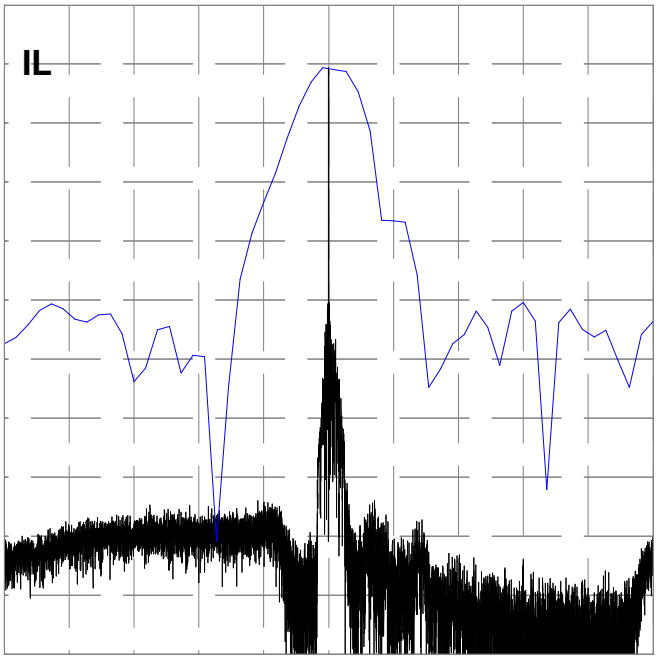
Typical Performance

Frequency Response
(Best Fit Quadratic Phase Removed)



10 dB/div, 10 deg/div, 25.000 MHz/div

Compressed Pulse Response
FFT(Frequency Response*Cos(0.5*PI*MIN(1,MAX(0,|f-F0|*8.0/B-4.0)))^2)



10 dB/div, 3.200 us/div, 0.011 us/div

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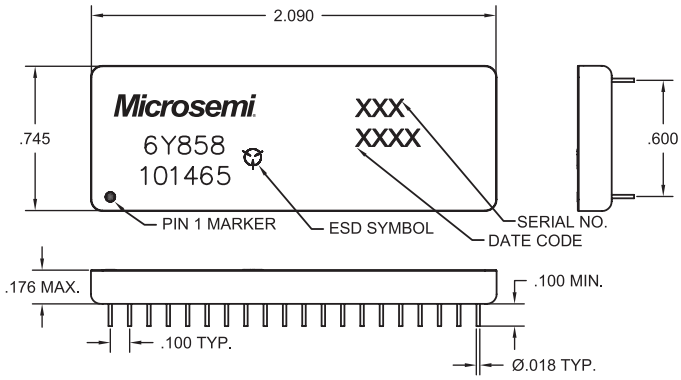
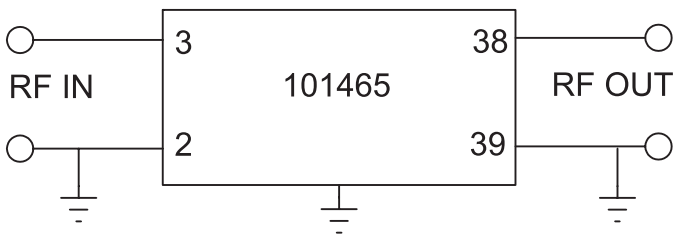
Package Outline



Matching



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